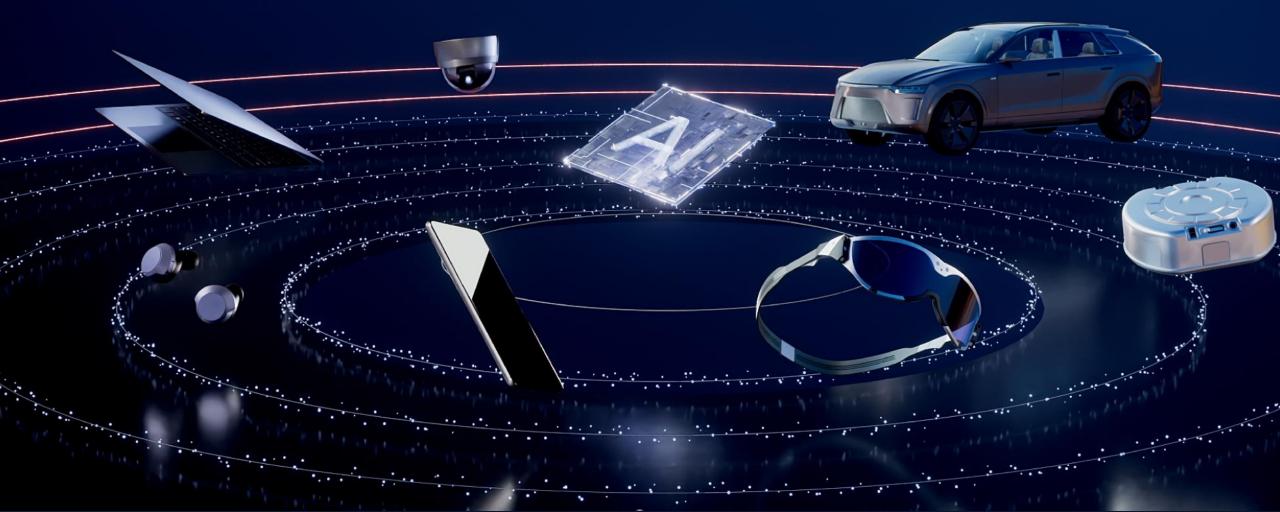
Felix Baum

Director, Al Product Management Qualcomm Technologies, Inc.

Qualcom

Powering the Connected Intelligent Edge



AI Challenges: Support structure across BU's

Performance optimization points

Innovative form factors are being constantly designed across many verticals and as such, one of the challenges is the ability to drive AI performance optimization (FPS or Latency or FPS/W) across multiple power envelopes

500mW or less

2W or less

5W of less

15W to 200W (Varying TDP points)

Support for different DL architectures and operators

Al based applications are quite widespread from image quality related (Mobile) to productivity (Compute) to assistance and monitoring (Auto ADAS) markets. This stretches Qualcomm's internal ecosystem to support:

Desired feature support across usecases and business

Ability to drive innovation using AI has seen increased traction in the ecosystem but the need for various feature support varies by BU vertical

Challenging DL architectures: Generative models (Mobile) to transformer models (Compute) to Lidar models

(Auto ADAS) which demands constant investment in compilers, tools, operators and other SW modules



• Support for high concurrency (For Auto and XR verticals)

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• Support for newer data types (For Data center verticals)



 Support for application scalability (For Mobile and Compute verticals)



AI Challenge: Performance optimization points

Leveraging mobile and scaling to multiple markets

Anchor point at Mobile

Adreno GPU

Processor

Security

Sensing

Hub

5G Modem-RF

System

Memory

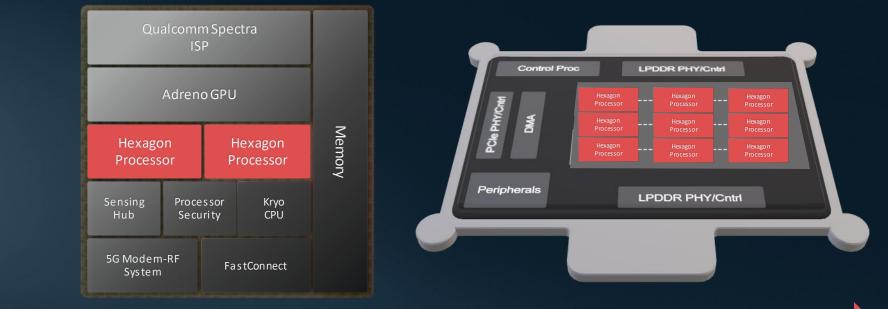
Kryo

CPU

FastConnect



Multiple AI cores at Cloud/Edge/Auto



Scalability and adaptability for different markets and AI needs

AI Challenge: Support for different DL architectures and operators

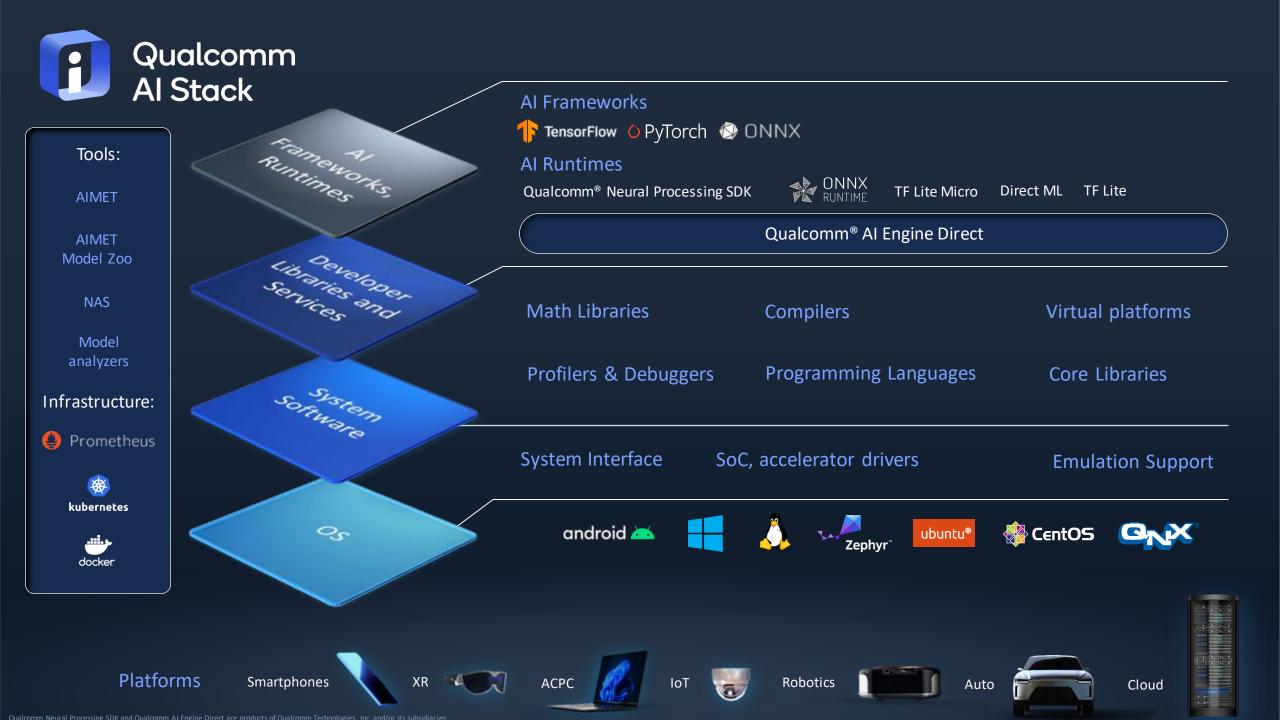
Leveraging mobile and scaling to multiple markets

- Customers need ability to drive innovation and many of them use ONNX models as an interchange format.
- By enabling direct conversion and preparation of the ONNX models into executable binaries we provide a seamless acceleration workflow from the training model to on device optimized execution
- Once our clients get to ONNX model they have ability to reuse the same model across the spectrum of performance of various Qualcomm SoCs.
- The benefit to Qualcomm is that it helps us to avoid building multiple converters
- To enable direct acceleration, we are collaborating with Microsoft to enable ONNX RT Execution Provider

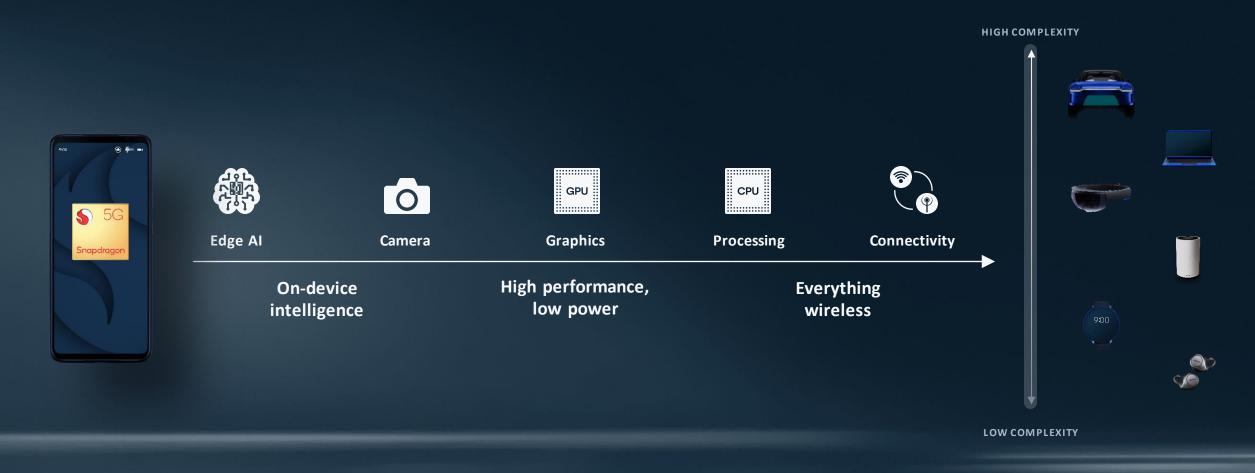
AI Challenge: Desired feature support across use-cases and business

Unified Qualcomm AI Software Stack provides allows portability across the vertical markets





One technology roadmap that scales to address all growth vectors



Thank you



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